

	Type	L #	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r s
1	BRS	L1	240	((illuminat\$4 or irradiati\$2) and etch\$) with (amorphous adj silicon)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 14:57		0
2	BRS	L8	115	1 and @pd<=19991114	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 14:42		0
3	BRS	L15	115	1 and @pd<=19991116	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 14:58		0
4	BRS	L22	93	((illuminat\$4 or irradiati\$2) with ((amorphous or alpha) adj silicon)) with (UV or blue or ultraviolet)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 14:57		0
5	BRS	L29	0	"93" same etchingetching	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 14:58		0
6	BRS	L36	1893	"93" same etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 15:37		0
7	BRS	L57	41	22 and etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 14:58		0
8	BRS	L64	18	57 and @pd<=19991116	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 18:09		0

	Type	L #	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r D e f i n i t i o n	E r r o r s
9	BRS	L43	4	22 same etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 14:59			0
10	BRS	L50	2	22 with etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 15:10			0
11	BRS	L71	14	64 not 43	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 15:10			0
12	BRS	L78	140	(light near3 damag\$3) same etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 15:38			0
13	BRS	L85	90	78 and @pd<=19991116	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 18:08			0
14	BRS	L92	44	"dangling bond" with (UV or ultraviolet or light) with (defect or damag\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 18:16			0
15	BRS	L99	27	92 and @pd<=19991116	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 18:09			0
16	BRS	L106	17	92 not 99	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 18:14			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r D e f i n i t i o n	E r r o r s
17	BRS	L113	2	"dangling bond" with (UV or ultraviolet) with (defect or damag\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/04 18:16			0